Intermixing at the In$_x$S$_y$/Cu$_2$ZnSn(S,Se)$_4$ Heterojunction and its Impact on the Chemical and Electronic Interface Structure

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Abstract
We report on the chemical and electronic structure of the interface between a thermally co-evaporated \( \text{In}_x\text{S}_y \) buffer and a \( \text{Cu}_2\text{ZnSn(S,Se)}_4 \) (CZTSSe) absorber for thin-film solar cells that, to date, has achieved energy conversion efficiencies up to 8.6 %. Using surface-sensitive x-ray and UV photoelectron spectroscopy, combined with inverse photoemission and bulk-sensitive soft x-ray emission spectroscopy, we find a complex character of the buffer layer. It includes oxygen, as well as selenium and copper that diffused from the absorber into the \( \text{In}_x\text{S}_y \) buffer, exhibits an electronic band gap of 2.50 ± 0.18 eV at the surface, and leads to a small cliff in the conduction band alignment at the \( \text{In}_x\text{S}_y/\text{CZTSSe} \) interface. After an efficiency-increasing annealing step at 180 °C in nitrogen atmosphere, additional selenium diffusion leads to a reduced band gap at the buffer layer surface (2.28 ± 0.18 eV).
I Introduction

Cu$_2$ZnSn(S,Se)$_4$ (CZTSSe, “kesterite”), composed of earth-abundant elements, has attracted intensive research interest as an absorber material for thin-film solar cells $^{1-5}$. For highest efficiencies, a CdS buffer layer is used, usually deposited via chemical bath deposition. However, the limited band gap of CdS (2.4 eV) leads to parasitic high-energy photon losses in the CdS buffer layer $^6$. Hence, promising alternatives like indium sulfide $^{4,7}$ or zinc oxysulfide [Zn(O,S)] $^{8,9}$ with larger band gaps (and different interface chemistries) are being investigated. Such alternative buffer layers are intensively pursued for the (related) Cu(In,Ga)(S,Se)$_2$ material system, and there is a growing interest to also investigate the impact of alternative buffer layers on the kesterite-based solar cell $^{5,6,10-12}$. In fact, the (to-date) significantly lower conversion efficiency of kesterite-based devices allows the speculation that other buffers might be better suited than the “standard” CdS developed for Cu(In,Ga)(S,Se)$_2$-based cells.

Apart from the differences of the buffer material properties, the interface between the buffer and the absorber film is expected to play an important role for the completed device, both with respect to the chemical (e.g., local bonding and intermixing) as well as electronic properties (e.g., the band alignment). In the case of the In$_x$S$_y$/CIGSSe interface, a diffusion of copper and selenium into the indium sulfide buffer has been reported previously $^{7,13,14}$. Here, we present a detailed analysis of the chemical and electronic structure of the In$_x$S$_y$/CZTSSe interface. To investigate an additional, efficiency-increasing process step, the In$_x$S$_y$ surface of a completed heterojunction after annealing in a nitrogen-filled glove box was also analyzed. For the analysis of the chemical structure, soft x-ray emission spectroscopy (XES) and x-ray photoelectron spectroscopy (XPS) were employed. To determine the valence and conduction band alignment at the buffer/absorber interface, we additionally used ultra-violet photoelectron spectroscopy (UPS) and inverse photoemission spectroscopy (IPES).
At the ZSW, CZTSSe absorbers were prepared from solution, using metal salts, thiourea, and dimethyl sulfoxide (DMSO) as solvent. The precursor solution was deposited onto a molybdenum substrate by doctor-blading and subsequently annealed under Se-atmosphere for 15 minutes at 550°C, resulting in chemical composition ratios of Cu/(Zn+Sn) = 0.85 and Zn/Sn = 1.24. For further details, the reader is referred to Ref. 1. The absorbers were stored for several days in a nitrogen-filled glovebox, and indium sulfide (In$_x$S$_y$) buffer layers with different thicknesses (up to 25 nm) were then thermally evaporated from an In$_2$S$_3$ powder at a pressure of ~$10^{-6}$ mbar. The thickness of the In$_x$S$_y$ layers was estimated based on the evaporation time and reflectivity measurements.

Six identical cells with this layer structure were processed by adding 40 nm intrinsic ZnO (i-ZnO) and a 400 nm aluminum-doped ZnO (ZnO:Al) layer$^{15}$. Devices with the corresponding glass/Mo/CZTSSe/In$_x$S$_y$/i-ZnO/ZnO:Al structure achieved efficiencies of up to $\eta = 6.3 \%$. After a short (15 minutes, 180°C in air) annealing step of the full solar cell, the short circuit current density $J_{sc}$ decreases from 36.1 mA/cm$^2$ by $\sim 9 \%$, while the open circuit voltage $V_{oc}$ increases from 426 to 436 mV and the fill factor (FF) from 40.6 to 60.0 %. This leads to an efficiency increase (up) to 8.6 %, which is the highest reported efficiency (to date) for a CZTSSe-based cell with indium sulfide buffer. The current density-voltage curves and parameters of the best device are shown in the Supporting Information (SI). To investigate the influence of this annealing step on the interface, it was mimicked by annealing a 25 nm In$_x$S$_y$/CZTSSe interface sample in a nitrogen-filled glovebox (for 15 min at 180 °C in N$_2$).

Samples for surface analysis were sealed under nitrogen atmosphere and shipped to UNLV for XPS, UPS, and IPES measurements. There, the samples were transferred into ultra-high vacuum (UHV) without additional air exposure. XPS (Mg and Al K$_\alpha$) and UPS (He I and II) measurements were
performed with a SPECS PHOIBOS 150 MCD electron analyzer. The analyzer was calibrated according to Ref. 16 using sputter-cleaned Au, Ag, and Cu reference foils. The Au foil was also used to calibrate the Fermi energy for UPS and IPES measurements. For the XPS/UPS/IPES measurements, the Cu$_2$ZnSn(S,Se)$_4$ absorber sample was cleaned with a 50 eV Ar$^+$-ion treatment for a total of 60 minutes (two 30-minute treatments). The 25 nm In$_x$S$_y$/CZTSSe and the N$_2$-annealed 25 nm In$_x$S$_y$/CZTSSe samples were cleaned for 30 minutes, while the intermediate buffer layer/CZTSSe samples were studied as-received (i.e., without treatment). XPS measurements after each cleaning step confirm that the Ar$^+$-ion treatment removes C and O contaminations without the formation of metallic phases 17–20, which are commonly found when sputter-cleaning at higher ion energies. IPES spectra were recorded using a Staib low-energy electron gun and a custom-built Dose-type detector with I$_2$:Ar filling. After taking the XPS, UPS, and IPES dataset, the samples were again sealed under nitrogen atmosphere and shipped to the ALS. The XES measurements were performed at Beamline 8.0.1, using the SALSA endstation 21. The S L$_{2,3}$ XES spectra were calibrated using a CdS single crystal reference 22.

![XPS survey spectra](image)

**Fig. 1:** XPS survey spectra of the CZTSSe absorber and the 2.5, 4, 7, and 25 nm In$_x$S$_y$/CZTSSe samples, as well as a 25 nm In$_x$S$_y$/CZTSSe sample after
annealing in N\textsubscript{2} at 180 °C. Prominent photoelectron and Auger features are labeled.

**III Results and Discussion**

Figure 1 shows the XPS survey spectra of the In\textsubscript{x}S\textsubscript{y}/CZTSSe sample series with increasing buffer layer thickness from bottom to top. The most prominent photoelectron and Auger lines are labeled. For the spectrum of CZTSSe, peaks related to all absorber elements (e.g., Cu 2p, Zn 2p, Sn 3d, S LMM, Se 3d), as well as a small Na 1s peak, are clearly visible. As for chalcopyrite-based thin-film solar cells\textsuperscript{23,24}, sodium diffuses from the soda-lime glass substrate into the back contact, the absorber, and to the absorber surface during the absorber preparation process. It is known to play a crucial role for the performance of kesterite-based solar cells\textsuperscript{25,26}. Very low C 1s and O 1s signals suggest that the vast majority of carbon- and oxygen-related adsorbates was successfully removed during the ion treatment. For increasing In\textsubscript{x}S\textsubscript{y} thickness, the absorber-related peaks are increasingly attenuated - for the 7 nm In\textsubscript{x}S\textsubscript{y}/CZTSSe sample, most of the absorber peaks are no longer visible, which suggests a closed In\textsubscript{x}S\textsubscript{y} layer on the CZTSSe absorber. In parallel, In- and S-related peaks become more prominent. Furthermore, small selenium and sodium signals are still found on the 25 nm In\textsubscript{x}S\textsubscript{y}/CZTSSe surface. After the annealing step at 180 °C, the Se 3d signal increases by a factor of ~3, while the sodium intensity remains constant. This suggests selenium diffusion upon deposition and, additionally, after the annealing step. For Cu(In,Ga)(S,Se)\textsubscript{2} thin-film solar cells, selenium is found to diffuse into In\textsubscript{x}S\textsubscript{y} buffer layers\textsuperscript{27}. The same behavior occurs for kesterites, which will be demonstrated in more detail below. In contrast to the absorber, a small O 1s and C 1s signal is detected for all buffer layer samples even after the ion treatment.
Fig 2. Top to bottom: S 2p/Se 3p XPS spectra of the CZTSSe absorber, the 25 nm In$_x$S$_y$/CZTSSe sample, and the annealed 25 nm In$_x$S$_y$/CZTSSe sample. The fit visualizes the different spectral components, and the magnified (x3) residual is shown below each spectrum.

To gain a more detailed picture of selenium diffusion into the In$_x$S$_y$ buffer layer, we analyze the S 2p/Se 3p core level region. For this purpose, we have fitted the corresponding photoelectron features with a linear background function and several Voigt profiles. For the simultaneous fit of the dataset, the Gaussian and Lorentzian widths for each spin-orbit doublet were coupled, their intensity ratio was fixed to 2:1 (according to the multiplicity 2j+1), and the spin-orbit splitting was also used as a fit parameter (resulting in a S 2p and Se 3p spin-orbit splitting of 1.19 eV and 5.84 eV, respectively). The resulting fits for the absorber, the 25 nm In$_x$S$_y$/CZTSSe, and the annealed 25 nm In$_x$S$_y$/CZTSSe sample are shown in Figure 2. The CZTSSe absorber spectrum needs to be fitted with a S 2p doublet and two Se 3p doublets (the
second doublet is marked with a prime in Fig. 2). The first Se species (black, Se 3p\textsubscript{3/2} at 160.2 eV) can likely be assigned to a selenide compound (e.g., CZTSSe)\textsuperscript{28}. The second species (Se’ 3p\textsubscript{3/2} at 161.5 eV) can tentatively be assigned to selenium in an oxidized environment, while also an elemental Se environment has been reported for such binding energies\textsuperscript{29,30}. Accordingly, a second Se component is also found in the Se 3d line of the CZTSSe absorber (not shown; the second Se 3d\textsubscript{5/2} line is shifted by 1.7 eV, from 54.0 to 55.7 eV). The sulfur 2p\textsubscript{3/2} peak at 161.0 eV matches the energetic position of sulfur in a sulfide environment\textsuperscript{17}.

For increasing buffer layer thickness, the selenium peaks are attenuated and the sulfur peaks gain in intensity (as expected). For the 25 nm \(\text{In}_x\text{S}_y/\text{CZTSSe}\) sample, the main S 2p\textsubscript{3/2} peak is shifted by 0.73 eV (relative to the CZTSSe absorber) to 161.7 eV, indicating a different sulfide environment in the buffer. This is supported by the modified indium Auger parameter \(\alpha'\text{In}\) of the 25 nm \(\text{In}_x\text{S}_y/\text{CZTSSe}\) sample of \((852.5 \pm 0.1)\) eV, which suggests the presence of Cu-In-S bonds\textsuperscript{16,31,32}. For all \(\text{In}_x\text{S}_y\) samples, a second S 2p component at higher binding energies is detected, which nevertheless still matches the energy region of sulfides. We speculate that this S 2p component belongs to a second \(\text{In}_x\text{S}_y\)-like phase (e.g., \(\text{In}_6\text{S}_7\) or \(\text{CuIn}_5\text{S}_8\)) or to sulfide in the vicinity of oxygen (e.g., as a next-nearest neighbor).

As mentioned above, a small Se 3p signal is also detected for the 25 nm \(\text{In}_x\text{S}_y/\text{CZTSSe}\) sample. After the 180°C annealing step (i.e., for the annealed 25 nm \(\text{In}_x\text{S}_y/\text{CZTSSe}\) sample, bottom spectrum in Fig. 2), the Se 3p signal contribution becomes more pronounced, revealing an annealing-induced Se diffusion. In contrast, no Sn or Zn signals are detected at the \(\text{In}_x\text{S}_y\) surface, ruling out the creation of pinholes/cracks in the buffer film.
**FIG 3:** Effective buffer layer thickness $d_{\text{eff}}$, calculated from the attenuation of different absorber-related peaks, as a function of the nominal buffer layer thickness, estimated from the buffer layer growth time. The effective buffer layer thickness for the Se 3d peak lies significantly below the dashed line, indicating its diffusion during buffer layer growth as well as after annealing. For clarity, the 25 nm Se 3d data point is slightly shifted to the right.

In order to obtain a more detailed picture of the diffusion process, we calculate an “effective buffer layer thickness” from the attenuation of the most prominent absorber-related peaks. Assuming a buffer layer of homogeneous thickness $d$ and no diffusion, the intensity of an XPS line is expressed by $I = I_0 \times e^{-d/\lambda}$, where $I_0$ is the line intensity for the absorber sample and $\lambda$ the inelastic mean free path (IMFP), which was calculated using QUASES-IMFP $^{33,34}$. Based on this, we define an “effective buffer layer thickness” as $d_{\text{eff}} = \lambda \ln(I_0/I)$ and plot it in Fig. 3 vs. the nominal buffer layer thickness as estimated from the buffer deposition time. If no diffusion occurs, the “effective buffer layer thickness” should be equal to the nominal buffer layer thickness, which is marked by the dashed line in Fig. 3. The values derived from the Zn and Sn 3d peaks agree with this line within the error bars, suggesting no diffusion of these elements. While the Cu 2p values also
lie on this line for buffer layer thicknesses up to (including) 7 nm, a small Cu 2p peak is still visible for the 25 nm In$_x$S$_y$/CZTSSe sample. The attenuation analysis derives an effective thickness of 4 nm, well below the nominal value of 25 nm, suggesting a weak copper diffusion into the In$_x$S$_y$ buffer layer. It should be noted that we do not see any additional copper diffusion upon annealing (Fig. 3, right), which is indicated by the same “effective buffer layer thickness” as for the non-annealed sample. Earlier studies on chalcopyrite-based interfaces show a strong impact of annealing on the copper diffusion $^{7,13,14}$. Those studies used annealing temperatures around 200 °C, while, for the present study, 180 °C was used.

The “effective buffer layer thickness” calculated from the selenium 3d peak attenuation lies significantly below the dashed line for all samples, which clearly indicates selenium diffusion during the buffer layer growth. After annealing, the calculated effective buffer layer thickness further decreases, which points towards an additional selenium diffusion upon annealing. Note that some earlier studies on In$_x$S$_y$ buffer layers also found a selenium diffusion $^{13,27}$, while others did not $^{7,14,32,35}$. Please note that, at room temperature, indium sulfide crystalizes in the $\beta$-In$_2$S$_3$ phase with a high number of vacancies. They can easily host other atoms$^{36}$, e.g., Na$^{27}$ or Cu$^7$ and possibly Se.
To study the chemical environment of the S atoms also with increased probing depth, we investigated the samples with XES. Here, the incoming and outgoing x-rays undergo an 1/e attenuation with attenuation lengths $\lambda_{\text{in}} = 53$ nm and $\lambda_{\text{out}} = 260$ nm, respectively. The S L$_{2,3}$ XES signal of the upper valence band region (150 - 165 eV emission energy) of the CZTSSe absorber, and of the 7 nm, 25 nm, as well as the annealed 25 nm In$_x$S$_y$/CZTSSe samples, are shown in Figure 4. In addition, the spectra of an indium sulfate [In$_2$(SO$_4$)$_3$] reference powder and a co-evaporated indium sulfide (In$_2$S$_3$) film are shown. The low sulfur content in the CZTSSe absorber sample results in a lower signal-to-noise ratio for the bottommost spectrum. The CZTSSe absorber spectrum contains several characteristic emission features. They can be assigned to electronic transitions from hybridized bands of the upper
valence region into the S 2p core holes. Accordingly, the region from 150 – 155 eV emission energy is dominated by Zn 3d-derived states and hybridized Sn 5s-S 3p states, indicating S-Zn and S-Sn bonds, respectively. The region from 158 – 162 eV is dominated by hybridized Cu 3d-S 3p states, thus indicative for S-Cu bonds. With increasing In$_x$S$_y$ thickness, the spectral signature changes, now also containing contributions from S-In bonds (as discussed in conjunction with Fig. 5 below). Furthermore, three additional features can be seen; two sharp features at ~154.7 eV and ~156.0 eV, and a broad feature at ~161.5 eV with a shoulder at ~163.5 eV. These features are most prominent for the 25 nm In$_x$S$_y$/CZTSSe sample and can be attributed to sulfur atoms in an oxide environment (e.g., sulfate)\textsuperscript{38–40}. We show In$_2$(SO$_4$)$_3$ as a reference for these S-O bonds (note that the formation of other sulfates and compounds with lower oxidation state might also contribute, especially for the shoulder at ~163.5 eV\textsuperscript{41}). After the annealing step, the spectral signature of the S-O bonds is removed.

In order to quantify the S L$_{2,3}$ XES spectra, we have fitted them with a sum of the CZTSSe absorber and the In$_2$S$_3$ and the In$_2$(SO$_4$)$_3$ references. This is exemplarily shown for the 25 nm In$_x$S$_y$/CZTSSe and the annealed 25 nm In$_x$S$_y$/CZTSSe films in Figure 5a) and b), respectively. The resulting weight factors of the three components are shown in Figure 5c). With increasing buffer layer thickness, the CZTSSe weight factor decreases (as expected) and those of In$_2$S$_3$ and In$_2$(SO$_4$)$_3$ increase. For the 25 nm In$_x$S$_y$/CZTSSe sample, the sulfate component is stronger than that of In$_2$S$_3$. After the annealing step, the sulfate fraction is significantly reduced, and the spectrum consists mainly of the In$_2$S$_3$ component (76%). We explain this as follows: Oxygen is built into the buffer layer (as oxides, hydroxides, and/or water), which is highlighted in the finding of S-O bonds. The annealing then likely reduces the oxygen content in the film, leading to a reduced contribution of S-O bonds to the spectrum of the (annealed) buffer layer.
In order to determine the band alignment at the InₓSᵧ/CZTSSe interface and to investigate the impact of the annealing on the electronic structure, we have used UPS and IPES and combined them with an XPS analysis of the core level positions. The UPS and IPES spectra of the ion-treated CZTSSe, 25 nm InₓSᵧ/CZTSSe, and annealed 25 nm InₓSᵧ/CZTSSe samples are shown on a common energy axis relative to Eᵋ in Fig. 6. The valence band maximum (VBM) and conduction band minimum (CBM) were determined with a linear extrapolation of the leading edge of the respective spectrum.\)

**FIG 5:** Three-component fit to reproduce a) the 25 nm InₓSᵧ/CZTSSe and b) the annealed 25 nm InₓSᵧ/CZTSSe S L₂,₃ XES spectra. The residuals are shown below each panel. c) The resulting weight factors of the three-component fit as a function of buffer layer thickness.
For the CZTSSe absorber, we derive the VBM and CBM to $0.60 \pm 0.10$ eV and $0.97 \pm 0.15$ eV, respectively. These positions indicate that the absorber’s downward band bending towards the surface is relatively weak. The sum of VBM and CBM, i.e., the electronic band gap at the surface ($1.57 \pm 0.18$ eV), is larger than the expected bulk band gap value of about $\sim 1.1$ eV $^1$. Such an increased surface band gap was found before for chalcopyrites $^{18,44}$ and kesterites $^{45,46}$ and can be attributed to a stoichiometry variation (often: a copper depletion) at the surface.

In the UPS spectra of the non-annealed and annealed 25 nm In$_x$S$_y$/CZTSSe samples, a tail is detected at about 1.8 eV that is larger than the experimental resolution. This can possibly be related to defect states close to the VBM or to real In$_x$S$_y$ states. A few published studies also show this broadening $^{32,47}$, while others do not $^{27,48}$. For other wide-gap conductive materials [(Zn,Mg)O], we have recently $^{49}$ interpreted such tails as

**FIG 6:** UPS and IPES spectra of the Cu$_2$ZnSn(S,Se)$_4$ absorber, the 25 nm In$_x$S$_y$/CZTSSe, and the annealed 25 nm In$_x$S$_y$/CZTSSe sample. All sample surfaces were cleaned with a 50 eV Ar$^+$ ion treatment. The spectra are plotted relative to the Fermi level, and all values are given in eV.
electronically active states that contribute to the excellent charge carrier transport, while the dominant edges in the UPS and IPES spectra are assigned to the optically relevant edges, giving rise to the wide-band gap character and transparency.

In our case, we have refrained from such a detailed analysis for the buffer layer, as these tails, at most, might lead to an overestimation of the buffer surface band gap and possibly impact the determination of the valence band offset (VBO). In contrast, the determination of the conduction band offset (CBO), which is the main focus of this interface alignment analysis, is not affected.

For the non-annealed 25 nm In$_x$S$_y$/CZTSSe sample, we determine the VBM and CBM to $1.76 \pm 0.10$ eV and $0.74 \pm 0.15$ eV, respectively, leading to an electronic surface band gap of $2.50 \pm 0.18$ eV. This value is slightly larger than the commonly reported literature values of $\sim 2.2 - 2.4$ eV for In$_2$S$_3$ and can be related to the presence of oxygen in the film, which is found to increase the In$_2$S$_3$ band gap $^{50}$, and possibly to the above-discussed broadening at the VBM.
FIG 7: Derived band alignment for the In$_x$S$_y$/CZTSSe interface (left), and VBM/CBM positions of the annealed In$_x$S$_y$/CZTSSe surface (right). A small cliff in the conduction band (-0.05 ± 0.20 eV) is found for the non-annealed interface. After annealing, the CBM of the buffer is shifted downwards, while the VBM is relatively unaffected. Electronic surface band gaps ($E_g$) are listed underneath each surface depiction. All values are given in eV.

To derive the band alignment, possible changes in the band edge positions induced by the formation of the interface need to be considered. For this purpose, we used the 2.5 and 4 nm buffer layers and measured the shifts of the absorber core levels as a function of buffer layer thickness. Here, we exclusively used the Sn 3d and Zn 3d lines, since copper- and selenium-related core levels might be influenced by the diffusion discussed above. The band bending in the buffer layer was evaluated by determining the relative shift of the In 3d and S 2p core levels for the thin buffer layer samples with respect to the 25 nm In$_x$S$_y$/CZTSSe sample. On average, we find a shift of -0.11 ± 0.08 eV and 0.07 ± 0.06 eV for the absorber- and buffer-related core levels, respectively. Based on this, we are able to derive the band alignment of the In$_x$S$_y$/CZTSSe interface, which is shown in Fig 7. We find a small cliff in the conduction band alignment (-0.05 ± 0.20) eV and a significant valence band offset (hole barrier) of (-0.98 ± 0.13) eV, respectively. Note that, within the error bars, a description with a “flat” conduction band alignment would also be applicable.

The impact of annealing on the VBM of the 25 nm In$_x$S$_y$/CZTSSe sample is small (+0.06 ± 0.05 eV), while a clear (-0.16 ± 0.05 eV) downward shift of the CBM (to 0.58 ± 0.15 eV) is found. Thus, we find a significantly smaller electronic surface band gap of 2.28 ± 0.18 eV for the annealed buffer. This decrease could be due to the reduction of oxygen in the film after the annealing step, as seen in the XES spectra in Figs. 4 and 5. Furthermore, the
diffusion of Se (energy gap of $\text{In}_2\text{Se}_3 \sim 1.5 \text{ eV}^{51}$) could decrease the band gap of the buffer layer.

Since the buffer layer thickness is significantly larger than $\lambda$, it is not possible to access the buried $\text{In}_x\text{S}_y$/CZTSSe interface, and hence it is not possible to determine the CBM and VBM of the annealed CZTSSe “surface”. The observed downward shift of the CBM, at first sight, would suggest an increase in the magnitude of the cliff (and hence an enhanced interface recombination). However, we point out that the observed Se diffusion, likely due to S/Se intermixing at the buffer/absorber interface$^{13,48,52,53}$, and the reduction of the amount of oxygen in the buffer layer might lead to a significantly altered interface alignment. This includes the fact that the offset might no longer be “vertical”, but smeared out along the compositional gradient at the junction.

It is reported$^{54-56}$ that a reduction of a cliff or even a change to a flat band alignment at the buffer/absorber interface can lead to an increase of the fill factor. We thus surmise that our findings lead to the significant increase of the fill factor and, hence, the increase in efficiency of the corresponding solar cells after the annealing process. Likely, the benefits of the annealing process also involve other aspects, beyond a simple view of the $\text{In}_x\text{S}_y$/CZTSSe interface band alignment.

**IV Summary**

In summary, we have investigated the chemical and electronic properties of the $\text{In}_x\text{S}_y$/CZTSSe interface before and after annealing. Upon deposition, we find a copper and selenium diffusion into the buffer layer. Furthermore, our XPS and XES analysis suggests a significant amount of oxygen in the $\text{In}_x\text{S}_y$ buffer layer. This amount is strongly reduced by the annealing step. Without annealing, we find an electronic surface band gap of this buffer of $2.50 \pm 0.18 \text{ eV}$ and a small cliff alignment at the $\text{In}_x\text{S}_y$/CZTSSe interface. After the annealing step, the electronic surface band gap of the buffer layer is reduced
to 2.28 ± 0.18 eV, probably caused by a significant selenium diffusion and the reduction of the oxygen content in the layer.

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**Supporting Information**

J-V curves and parameters of the as-grown and annealed samples
References


